

# **Data Sheet**

### **Description**

The RG4C is a high voltage fast recovery diode of 1000 V / 2.0 A. The maximum  $t_{rr}$  of 100 ns is realized by optimizing a life-time control.

#### **Features**

• V <sub>RM</sub>	1000 V
• I <sub>F(AV)</sub>	
• V <sub>F</sub>	
• t <sub>rr1</sub>	

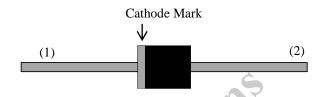
• Bare Leads: Pb-free (RoHS Compliant)

## **Applications**

- ot Recommended for Aerican • High Voltage Rectification Circuit (PFC Circuit, Bridge Circuit, etc.)
- Snubber Diode (Flyback Converter, etc.)

#### **Package**

Axial ( $\phi 6.5 \times 8.0 L / \phi 1.4$ )





- (1) Cathode
- (2) Anode

Not to scale

## **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage	$V_{RSM}$	1000	V	
Repetitive Reverse Voltage	$V_{RM}$	1000	V	
Average Forward Current	I <sub>F(AV)</sub>	2.0	A	See Figure 2 and Figure 3.
Surge Forward Current	$I_{FSM}$	60	A	Half cycle sine wave, positive side, 10 ms, 1 shot
I <sup>2</sup> t Limiting Value	I <sup>2</sup> t	18	$A^2s$	$1 \text{ ms} \le t \le 10 \text{ ms}$
Junction Temperature	$T_{\mathrm{J}}$	-40 to 150	°C	
Storage Temperature	$T_{STG}$	-40 to 150	°C	

#### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C

Unless otherwise specified, $I_A = 25^{\circ}$ C	•						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Forward Voltage Drop	$V_{\mathrm{F}}$	$T_J = 25  ^{\circ}\text{C}, I_F = 2.0  \text{A}$	_	_	2.0	V	
		$T_J = 100  ^{\circ}\text{C}, I_F = 2.0  \text{A}$	_	1.3		V	
Reverse Leakage Current	$I_R$	$V_R = V_{RM}$	_		0.5	mA	
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 100  ^{\circ}C$	_		2.5	mA	
	t <sub>rr1</sub>	$I_F = I_{RP} = 100 \text{ mA}$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_		100	ns	
Reverse Recovery Time	t <sub>m2</sub>	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ 75% recovery point, $T_J = 25 \text{ °C}$	_	_	50	ns	
Thermal Resistance (1)	$R_{th(J-L)}$	See Figure 1.			8.0	°C/W	
T <sub>L</sub> 15 mm  1.6 mm							

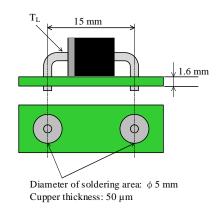
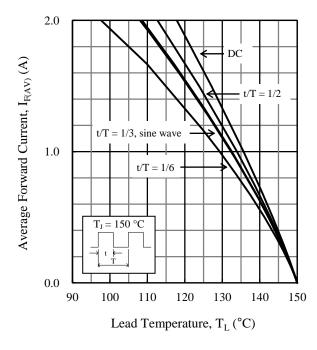


Figure 1 Lead Temperature Measurement Conditions

 $<sup>^{(1)}\,</sup>R_{\text{th (J-L)}}$  is thermal resistance between junction and lead.

### **Rating and Characteristic Curves**



 $Figure~2.~~I_{F(AV)}~vs.~T_L~Typical~Characteristics^{(2)}\\$  $(V_R = 0 V)$ 

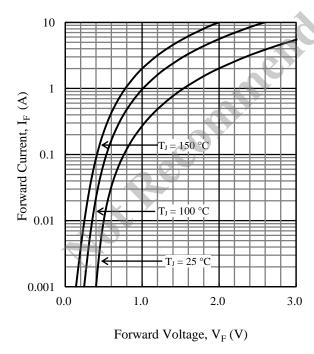
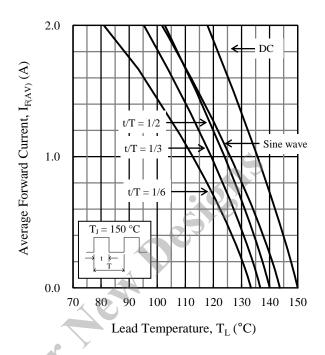


Figure 4. V<sub>F</sub> vs. I<sub>F</sub> Typical Characteristics



$$\begin{split} I_{F(AV)} \ vs. \ T_L \ Typical \ Characteristics^{(2)} \\ (V_R = 1000 \ V) \end{split}$$
Figure 3.

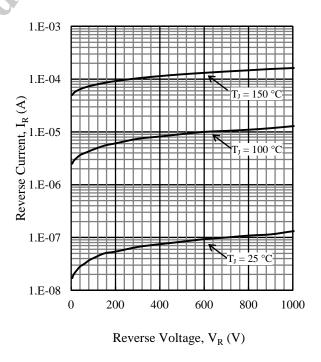


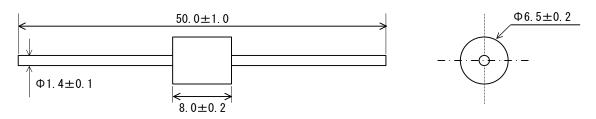
Figure 5. V<sub>R</sub> vs. I<sub>R</sub> Typical Characteristics

<sup>&</sup>lt;sup>(2)</sup> See Figure 1 for the lead temperature measurement conditions.

#### RG4C

#### **Physical Dimensions**

• Axial ( $\phi 6.5 \times 8.0 L / \phi 1.4$ )



#### **NOTES:**

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:

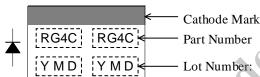
Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times

Aot Recons

Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

# **Marking Diagram**



Y is the last digit of the year of manufacture (0 to 9)

M is the month of the year (1 to 9, O, N or D)

D is the period of days represented by:

• : the first 10 days of the month (1st to 10th)

•• : the second 10 days of the month (11th to 20th)

••• : the last 10–11 days of the month (21st to 31st)

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